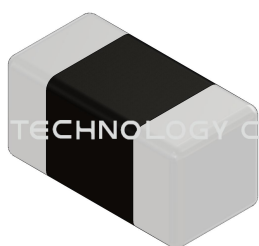


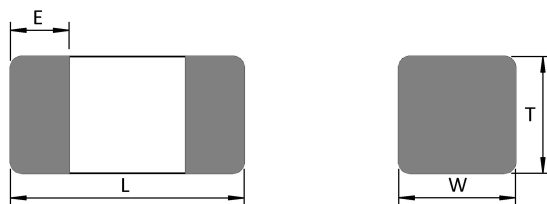
MCB1005H750FHP



Appearance & Shape



INPAQ TECHNOLOGY CO., LTD.



INPAQ TECHNOLOGY CO., LTD.



L	1.00±0.10
W	0.50±0.10
T	0.50±0.10
E	0.25±0.10

(unit:mm)



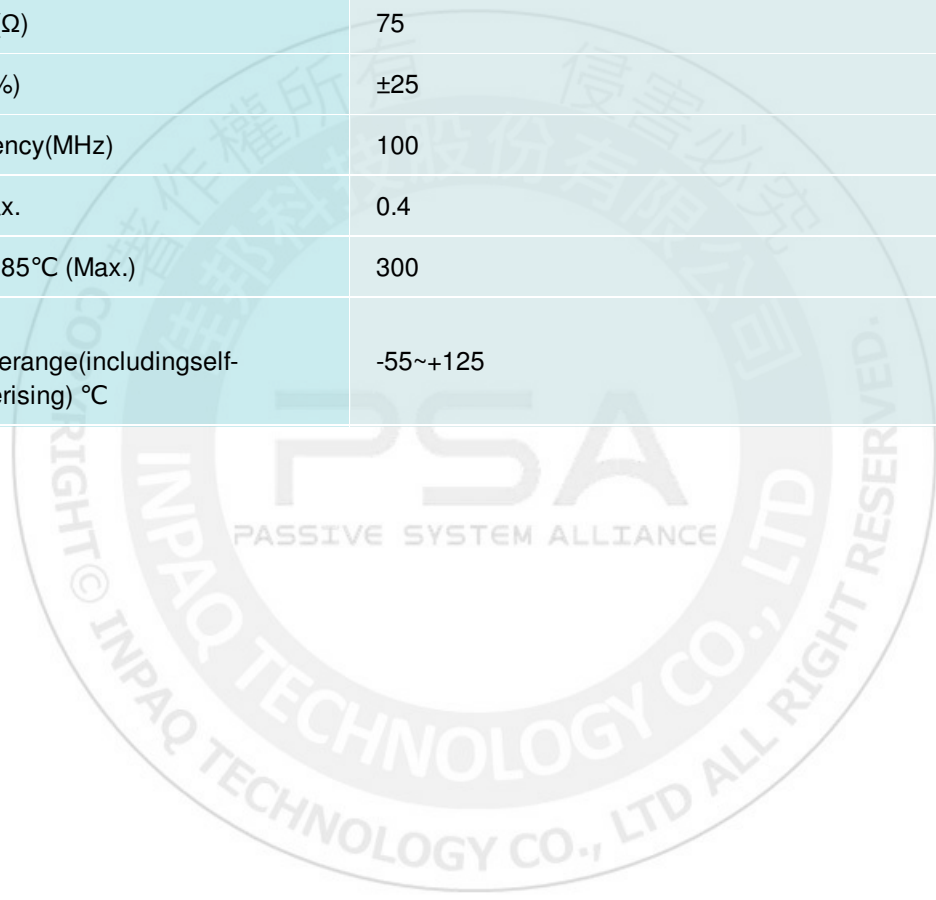
注意 NOTICE: All Specifications are subject to change without notice.

Page 1/4

1. 本文件由 INPAQ 佳邦科技網站下載，若規格變更及停產，請於訂購時確認，恕不另行通知。
2. 本文件僅說明參考標準規格，如需訂購，請依實際核准所需規格進行申辦。

Specification

L size(mm)	1.0±0.10
W size(mm)	0.5±0.10
T size(mm)	0.5±0.10
Size code Inch(mm)	0402(1005)
Impedance(Ω)	75
Tolerance(%)	±25
Test Frequency(MHz)	100
DCR(Ω) Max.	0.4
I _{rms} (mA) @85°C (Max.)	300
Operating Temperature range(including self-temperature rising) °C	-55~+125



注意 NOTICE: All Specifications are subject to change without notice.

Page 2/4

1. 本文件由 INPAQ 佳邦科技網站下載，若規格變更及停產，請於訂購時確認，恕不另行通知。
2. 本文件僅說明參考標準規格，如需訂購，請依實際核准所需規格進行申辦。

Notices

- Monolithic inorganic material construction
- Closed magnetic circuit avoids crosstalk
- SMD Type & suitable for reflow and wave soldering
- Available in various sizes
- Excellent solderability and heat resistance
- High reliability
- With a sharp and frequency frequency impedance characteristics which can effectively filter high frequency noise without attenuating high frequency signal.
- Compliant with AEC Q200

Packing

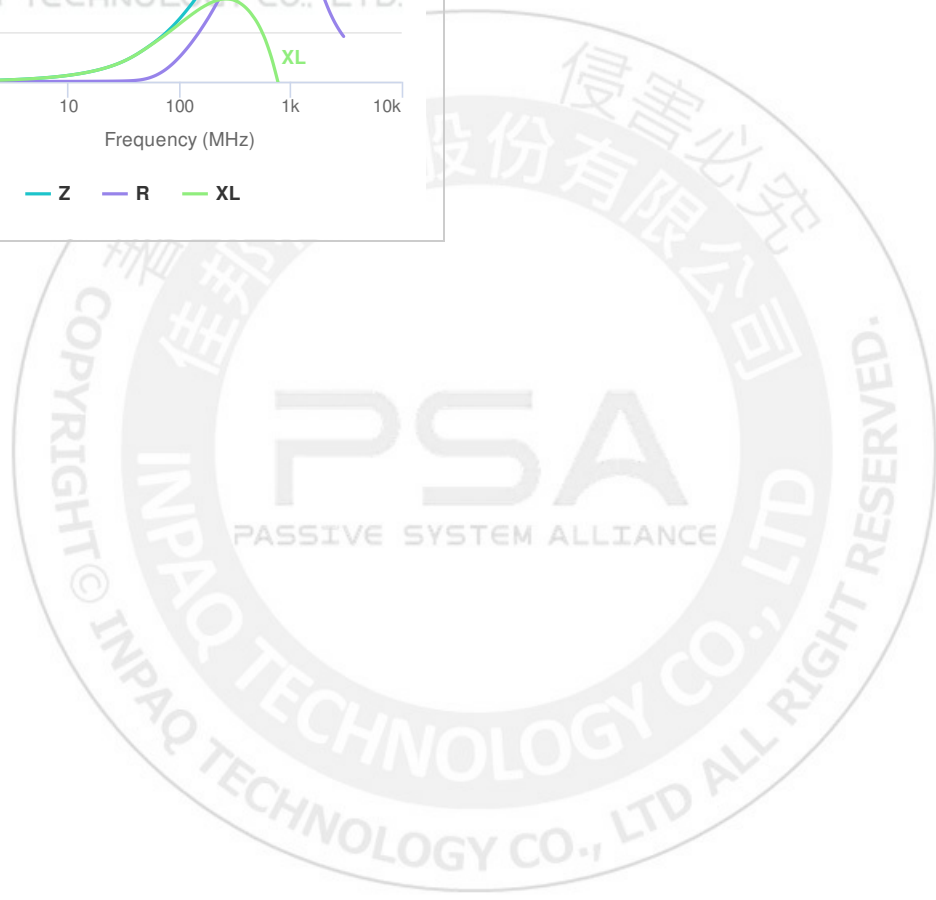
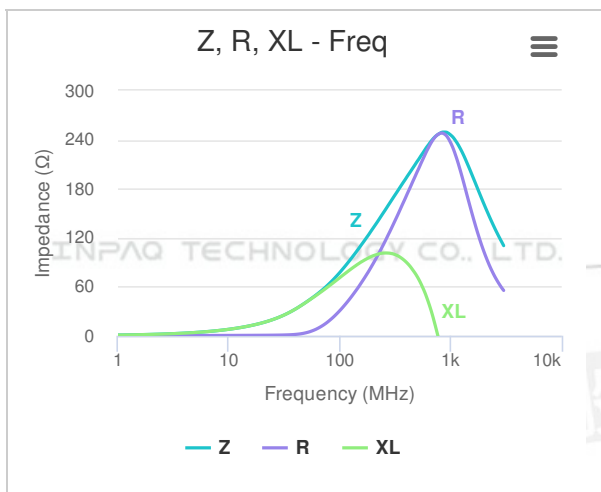
Packing Reel(Inch)	Packaging type	Standard package quantity(PCS)	Piece weight(gram)	MSL Level
7	Paper type	10000	0.0016	1

注意 NOTICE: All Specifications are subject to change without notice.

Page 3/4

1. 本文件由 INPAQ 佳邦科技網站下載，若規格變更及停產，請於訂購時確認，恕不另行通知。
2. 本文件僅說明參考標準規格，如需訂購，請依實際核准所需規格進行申辦。

Characteristic curve



注意 NOTICE: All Specifications are subject to change without notice.

1. 本文件由 INPAQ 佳邦科技網站下載，若規格變更及停產，請於訂購時確認，恕不另行通知。
2. 本文件僅說明參考標準規格，如需訂購，請依實際核准所需規格進行申辦。